# **IGBT - Field Stop, Trench**

650 V, 40 A

# FGH40T65SHDF

## Description

Using novel field stop IGBT technology, ON Semiconductor's new series of field stop 3<sup>rd</sup> generation IGBTs offer superior conduction and switching performance and easy parallel operation. This device is well suited for the resonant or soft switching application such as induction heating and MWO.

## Features

- Maximum Junction Temperature:  $T_J = 175^{\circ}C$
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage:  $V_{CE(sat)} = 1.45 V(Typ.) @ I_C = 40 A$
- 100% of the Parts Tested for ILM (Note 1)
- High Input Impedance
- Fast Switching
- Tighten Parameter Distribution
- This Device is Pb-Free and is RoHS Compliant

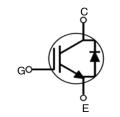
## Applications

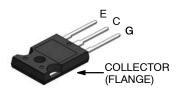
• Induction Heating, MWO



# **ON Semiconductor®**

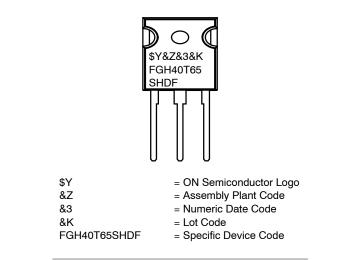
www.onsemi.com





TO-247-3LD CASE 340CH

## MARKING DIAGRAM



## ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

#### **ABSOLUTE MAXIMUM RATINGS**

Description		Symbol	FGH40T65SHDF-F155	Unit	
Collector to Emitter Voltage		V <sub>CES</sub>	650	V	
Gate to Emitter Voltage		V <sub>GES</sub>	±20	V	
Transient Gate to Emitter Voltage			±30	V	
Collector Current	$T_{\rm C} = 25^{\circ}{\rm C}$	Ι <sub>C</sub>	80	А	
Collector Current	T <sub>C</sub> = 100°C		40	А	
Pulsed Collector Current (Note 1)	$T_{\rm C} = 25^{\circ}{\rm C}$	I <sub>LM</sub>	120	А	
Pulsed Collector Current (Note 2)		I <sub>CM</sub>	120	А	
Diode Forward Current	$T_{\rm C} = 25^{\circ}{\rm C}$	١ <sub>F</sub>	40	А	
Diode Forward Current	T <sub>C</sub> = 100°C		20	А	
Pulsed Diode Maximum Forward Current		I <sub>FM</sub>	60	А	
Maximum Power Dissipation	$T_{\rm C} = 25^{\circ}{\rm C}$	PD	268	W	
Maximum Power Dissipation	T <sub>C</sub> = 100°C		134	W	
Operating Junction Temperature		TJ	–55 to +175	°C	
Storage Temperature Range		T <sub>stg</sub>	–55 to +175	°C	
Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 Seconds		ΤL	300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1.  $V_{CC} = 400 \text{ V}$ ,  $V_{GE} = 15 \text{ V}$ ,  $I_C = 120 \text{ A}$ ,  $R_G = 30 \Omega$ , Inductive Load 2. Repetitive Rating: Pulse width limited by max. junction temperature.

#### **THERMAL CHARACTERISTICS**

Parameter	Symbol	FGH40T65SHDF-F155	Unit
Thermal Resistance, Junction to Case (IGBT)	$R_{\theta JC}$	0.56	°C/W
Thermal Resistance, Junction to Case (Diode)	$R_{\theta JC}$	1.75	°C/W
Thermal Resistance, Junction to Ambient	$R_{ hetaJA}$	40	°C/W

#### PACKAGE MARKING AND ORDERING INFORMATION

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FGH40T65SHDF	FGH40T65SHDF-F155	TO-247-3LD	-	-	30

#### ELECTRICAL CHARACTERISTICS OF THE IGBT (T<sub>C</sub> = 25°C unless otherwise noted)

Parameter	Symbol	I Test Conditions		Тур	Max	Unit
OFF CHARACTERISTICS		·		-		
Collector to Emitter Breakdown Voltage	BV <sub>CES</sub>	$V_{GE} = 0 V, I_{C} = 1 mA$	650	-	-	V
Temperature Coefficient of Breakdown Voltage	$\Delta BV_{CES}/\Delta T_{J}$	$V_{GE} = 0 V, I_C = 1 mA$		0.6		V/°C
Collector Cut-Off Current	I <sub>CES</sub>	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μA
G-E Leakage Current	I <sub>GES</sub>	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
ON CHARACTERISTICS						
G-E Threshold Voltage	V <sub>GE(th)</sub>	$I_{C}$ = 40 mA, $V_{CE}$ = $V_{GE}$	3.5	5.5	7.5	V
Collector to Emitter Saturation Voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> = 40 A, V <sub>GE</sub> = 15 V	-	1.45	1.85	V
		$I_{C}$ = 40 A, $V_{GE}$ = 15 V, $T_{C}$ = 175°C	-	1.8	-	V

#### ELECTRICAL CHARACTERISTICS OF THE IGBT (T<sub>C</sub> = 25°C unless otherwise noted) (continued)

Parameter	Parameter Symbol Test Conditions		Min	Тур	Max	Unit
DYNAMIC CHARACTERISTICS		-	-	•		
Input Capacitance	C <sub>ies</sub>	$V_{CE}$ = 30 V, $V_{GE}$ = 0 V, f = 1 MHz	-	1982	-	pF
Output Capacitance	C <sub>oes</sub>	-	-	70	-	pF
Reverse Transfer Capacitance	C <sub>res</sub>	-	-	25	-	pF
SWITCHING CHARACTERISTICS	-					-
Turn-On Delay Time	T <sub>d(on)</sub>	$V_{CC} = 400 \text{ V, } I_C = 40 \text{ A,}$ $R_G = 6 \Omega, V_{GE} = 15 \text{ V,}$ Inductive Load, $T_C = 25^{\circ}C$	-	18	-	ns
Rise Time	T <sub>r</sub>		-	27	-	ns
Turn-Off Delay Time	T <sub>d(off)</sub>		-	64	-	ns
Fall Time	T <sub>f</sub>		-	3	-	ns
Turn-On Switching Loss	E <sub>on</sub>		-	1.22	-	mJ
Turn-Off Switching Loss	E <sub>off</sub>	7	-	0.44	-	mJ
Total Switching Loss	E <sub>ts</sub>	7	-	1.66	-	mJ
Turn-On Delay Time	T <sub>d(on)</sub>	$\label{eq:V_CC} \begin{array}{l} V_{CC} = 400 \text{ V}, \text{ I}_{C} = 40 \text{ A}, \\ R_{G} = 6 \ \Omega, \text{ V}_{GE} = 15 \text{ V}, \\ \text{Inductive Load, } T_{C} = 175^{\circ}\text{C} \end{array}$	-	18	-	ns
Rise Time	T <sub>r</sub>		-	31	-	ns
Turn-Off Delay Time	T <sub>d(off)</sub>		-	70	-	ns
Fall Time	T <sub>f</sub>	7	-	56	-	ns
Turn-On Switching Loss	E <sub>on</sub>	7	-	1.78	-	mJ
Turn–Off Switching Loss	E <sub>off</sub>		-	0.78	-	mJ
Total Switching Loss	E <sub>ts</sub>		-	2.56	-	mJ
Total Gate Charge	Qg	$V_{\rm CC} = 400 \text{ V}, \text{ I}_{\rm C} = 40 \text{ A},$	-	68	-	nC
Gate to Emitter Charge	Q <sub>ge</sub>	V <sub>GE</sub> = 15 V	-	12	-	nC
Gate to Collector Charge	Q <sub>gc</sub>	1	_	25	_	nC

### **ELECTRICAL CHARACTERISTICS OF THE DIODE** ( $T_J$ = 25°C unless otherwise noted)

Parameter	Symbol	Test Conditions		Min	Тур	Max	Unit
Diode Forward Voltage	V <sub>FM</sub>	I <sub>F</sub> = 20 A	$T_C = 25^{\circ}C$	-	1.5	1.95	V
			T <sub>C</sub> = 175°C	-	1.37	-	
Reverse Recovery Energy	E <sub>rec</sub>	I <sub>F</sub> = 20 A, dI <sub>F</sub> /dt = 200 A/μs	T <sub>C</sub> = 175°C	-	153	-	μJ
Diode Reverse Recovery Time	T <sub>rr</sub>		$T_C = 25^{\circ}C$	-	101	-	ns
			T <sub>C</sub> = 175°C	-	238	-	
Diode Reverse Recovery Charge	Q <sub>rr</sub>		$T_{C} = 25^{\circ}C$	-	343	-	nC
			T <sub>C</sub> = 175°C	-	1493	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

## **TYPICAL PERFORMANCE CHARACTERISTICS**

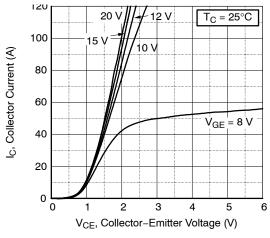


Figure 1. Typical Output Characteristics

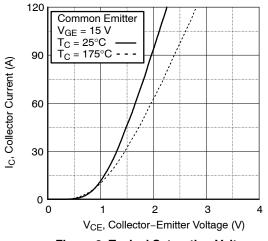
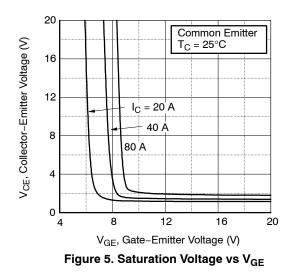


Figure 3. Typical Saturation Voltage Characteristics



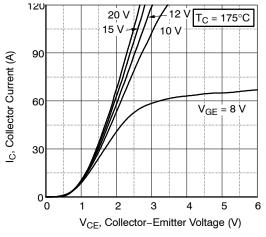


Figure 2. Typical Output Characteristics

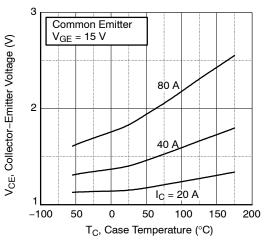
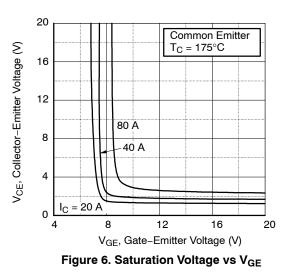


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level



## TYPICAL PERFORMANCE CHARACTERISTICS (continued)

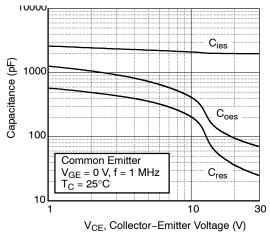


Figure 7. Capacitance Characteristics

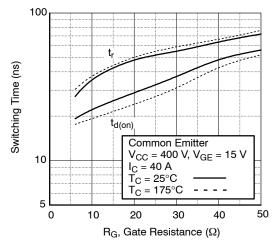


Figure 9. Turn-On Characteristics vs. Gate Resistance

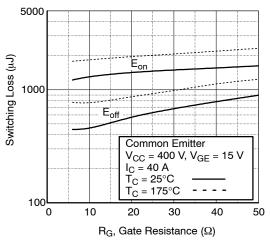
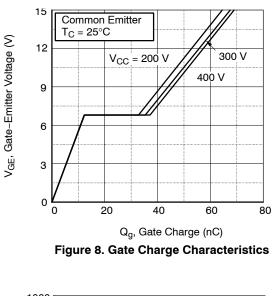


Figure 11. Switching Loss vs. Gate Resistance



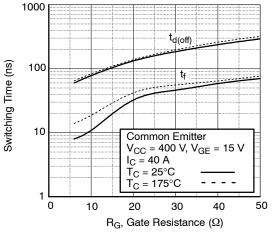


Figure 10. Turn-Off Characteristics vs. Gate Resistance

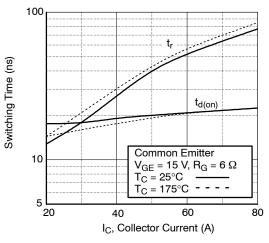
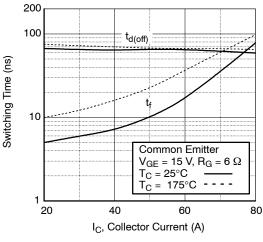
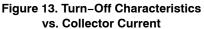


Figure 12. Turn-On Characteristics vs. Collector Current

### TYPICAL PERFORMANCE CHARACTERISTICS (continued)





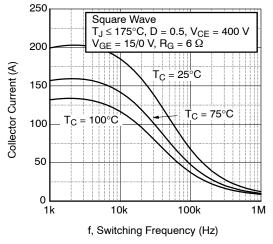
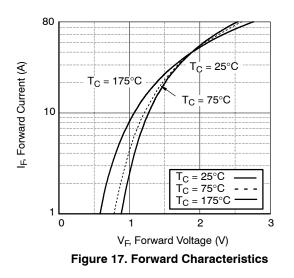


Figure 15. Load Current vs. Frequency



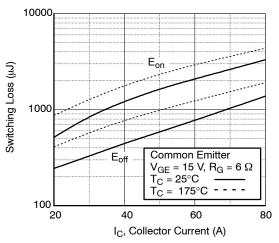
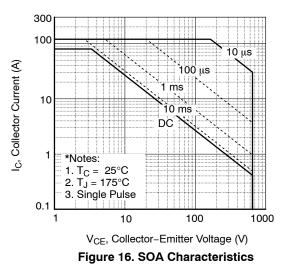
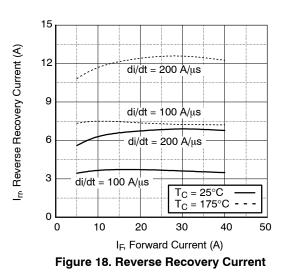
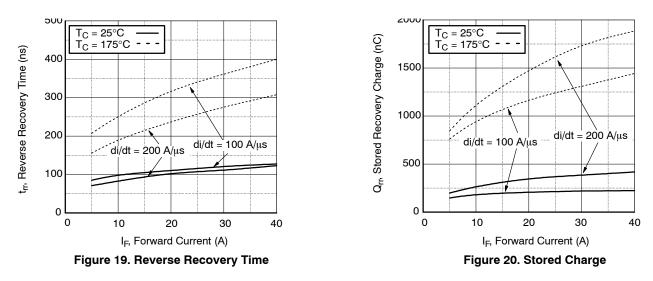


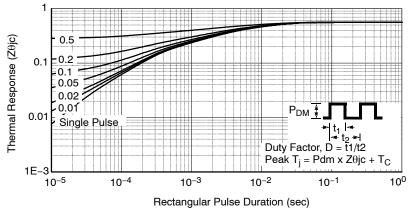
Figure 14. Switching Loss vs. Collector Current



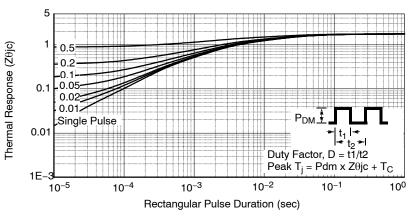


## TYPICAL PERFORMANCE CHARACTERISTICS (continued)



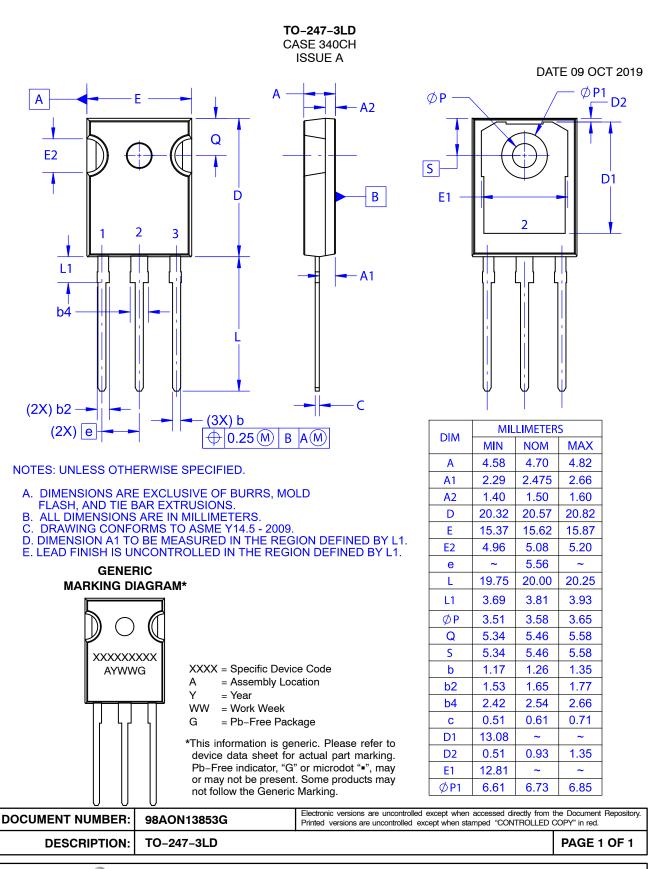












ON Semiconductor and use trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent\_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

#### ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>